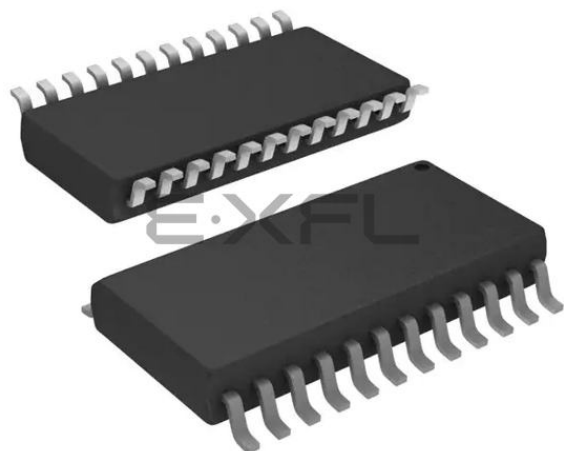




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding Embedded - PLDs (Programmable Logic Devices)

Embedded - PLDs, or Programmable Logic Devices, are a type of digital electronic component used to build reconfigurable digital circuits. Unlike fixed-function logic devices, PLDs can be programmed to perform specific functions by the user. This flexibility allows designers to customize the logic to meet the exact needs of their applications, making PLDs a crucial component in modern embedded systems.

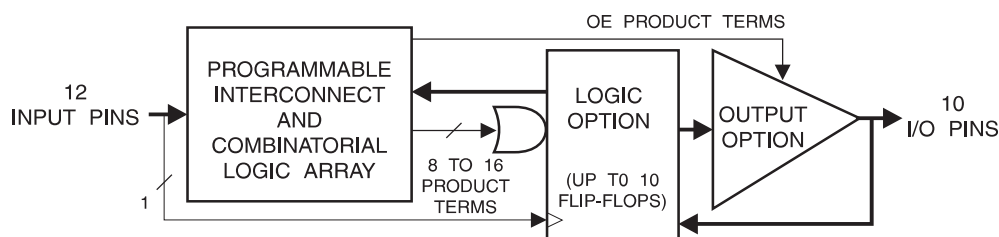
Applications of Embedded - PLDs (Programmable Logic Devices)

The versatility of PLDs makes them suitable for a wide range of applications. In consumer electronics, PLDs are used to enhance the functionality and performance of

Details

Product Status	Obsolete
Programmable Type	EE PLD
Number of Macrocells	10
Voltage - Input	5V
Speed	7.5 ns
Mounting Type	Surface Mount
Package / Case	24-SOIC (0.295", 7.50mm Width)
Supplier Device Package	24-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atf22v10c-7sc

Figure 1-1. Logic Diagram



2. Pin Configurations

Table 2-1. Pin Configurations (All Pinouts Top View)

Pin Name	Function
CLK	Clock
IN	Logic Inputs
I/O	Bi-directional Buffers
GND	Ground
VCC	+5V Supply
PD	Power-down

Figure 2-1. TSSOP

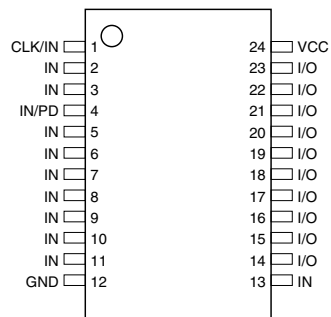


Figure 2-2. DIP/SOIC

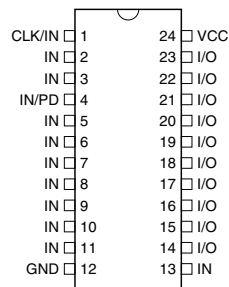
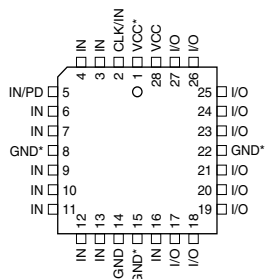


Figure 2-3. PLCC/LCC



Note: For all PLCCs (except “-5”), pins 1, 8, 15 and 22 can be left unconnected. However, if they are connected, superior performance will be achieved

3. Absolute Maximum Ratings*

Temperature under Bias	-55°C to +125°C
Storage Temperature.....	-65°C to +150°C
Voltage on Any Pin with Respect to Ground.....	-2.0V to +7.0V ⁽¹⁾
Voltage on Input Pins with Respect to Ground during Programming	-2.0V to +14.0V ⁽¹⁾
Programming Voltage with Respect to Ground.....	-2.0V to +14.0V ⁽¹⁾

*NOTICE: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20ns.
Maximum output pin voltage is $V_{CC} + 0.75V$ DC, which may overshoot to 7.0V for pulses of less than 20ns.

4. DC and AC Operating Conditions

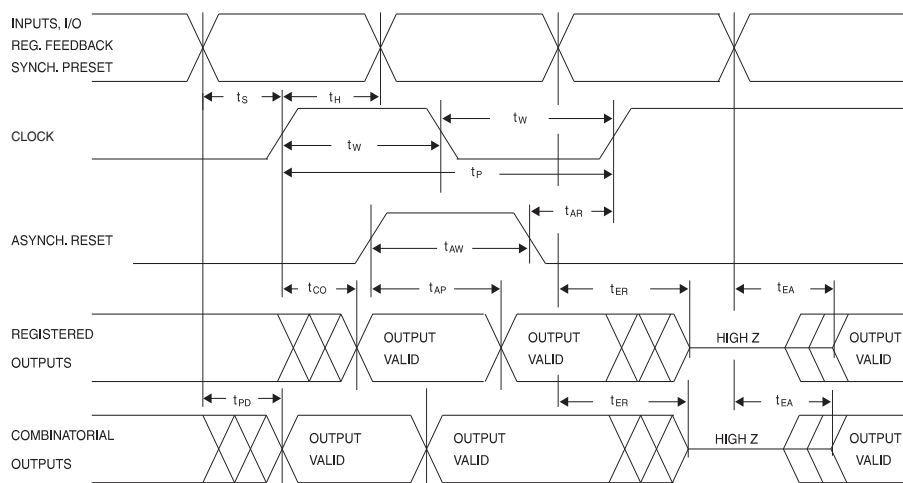
	Commercial	Industrial	Military
Operating Temperature (Ambient)	0°C - 70°C	-40°C - 85°C	-55°C - 125°C (case)
V_{CC} Power Supply	5V ± 5%	5V ± 10%	5V ± 10%

4.1 DC Characteristics

Symbol	Parameter	Condition			Min	Typ	Max	Units
I _{IL}	Input or I/O Low Leakage Current	0 ≤ V _{IN} ≤ V _{IL} (Max)					-10.0	μA
I _{IH}	Input or I/O High Leakage Current	3.5 ≤ V _{IN} ≤ V _{CC}					10.0	μA
I _{CC}	Power Supply Current, Standby	V _{CC} = Max, V _{IN} = Max, Outputs Open	C-5, 7, 10	Com.		85.0	130.0	mA
			C-10	Ind.		90.0	140.0	mA
			C-15	Ind.		65.0	115.0	mA
			CQ-15	Ind.		35.0	70.0	mA
I _{CC2}	Clocked Power Supply Current	V _{CC} = Max, Outputs Open, f = 15MHz	C-5, 7, 10	Com.			150.0	mA
			C-10	Ind., Mil.			160.0	mA
			C-15	Ind.	70.0		125	mA
			C-15	Mil.			160.0	mA
			CQ-15	Ind.		40.0	80.0	mA
I _{PD}	Power Supply Current, PD Mode	V _{CC} = Max		Com.		10.0	500.0	μA
		V _{IN} = 0, Max		Ind.		10.0	650.0	μA
I _{OS} ⁽¹⁾	Output Short Circuit Current	V _{OUT} = 0.5V					-130.0	mA
V _{IL}	Input Low Voltage				-0.5		0.8	V
V _{IH}	Input High Voltage				2.0		V _{CC} +0.75	V
V _{OL}	Output Low Voltage	V _{IN} = V _{IH} or V _{IL} , V _{CC} = Min	I _{OL} = 16mA	Com., Ind.			0.5	V
			I _{OL} = 12mA	Mil.			0.5	V
V _{OH}	Output High Voltage	V _{IN} = V _{IH} or V _{IL} , V _{CC} = Min	I _{OH} = -4.0mA		2.4			V

Note: 1. Not more than one output at a time should be shorted. Duration of short circuit test should not exceed 30 sec

4.2 AC Waveforms ⁽¹⁾



Note: 1. Timing measurement reference is 1.5V. Input AC driving levels are 0.0V and 3.0V, unless otherwise specified

4.3 AC Characteristics⁽¹⁾

Symbol	Parameter	-5		-7		-10		-15		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t_{PD}	Input or Feedback to Combinatorial Output	1.0	5.0	3.0	7.5	3.0	10.0	3.0	15.0	ns
t_{CO}	Clock to Output	1.0	4.0	2.0	4.5 ⁽²⁾	2.0	6.5	2.0	8.0	ns
t_{CF}	Clock to Feedback		2.5		2.5		2.5		2.5	ns
t_S	Input or Feedback Setup Time	3.0		3.5		4.5		10.0		ns
t_H	Hold Time	0		0		0		0		ns
f_{MAX}	External Feedback $1/(t_S + t_{CO})$	142.0		125.0 ⁽³⁾		90.0		55.5		MHz
	Internal Feedback $1/(t_S + t_{CF})$	166.0		142.0		117.0		80.0		MHz
	No Feedback $1/(t_{WH} + t_{WL})$	166.0		166.0		125.0		83.3		MHz
t_W	Clock Width (t_{WL} and t_{WH})	3.0		3.0		3.0		6.0		ns
t_{EA}	Input or I/O to Output Enable	2.0	6.0	3.0	7.5	3.0	10.0	3.0	15.0	ns
t_{ER}	Input or I/O to Output Disable	2.0	5.0	3.0	7.5	3.0	9.0	3.0	15.0	ns
t_{AP}	Input or I/O to Asynchronous Reset of Register	3.0	7.0	3.0	10.0	3.0	12.0	3.0	20.0	ns
t_{AW}	Asynchronous Reset Width	5.5		7.0		8.0			15.0	ns
t_{AR}	Asynchronous Reset Recovery Time	4.0		5.0		6.0			10.0	ns
t_{SP}	Setup Time, Synchronous Preset	4.0		4.5		6.0			10.0	ns
t_{SPR}	Synchronous Preset to Clock Recovery Time	4.0		5.0		8.0			10.0	ns

- Notes:
1. See ordering information for valid part numbers
 2. 5.5ns for DIP package devices
 3. 111MHz for DIP package devices

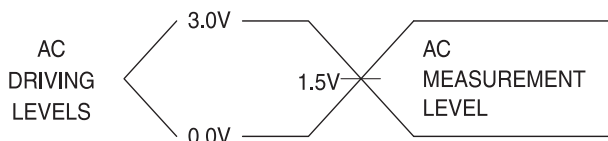
4.4 Power-down AC Characteristics⁽¹⁾⁽²⁾⁽³⁾

Symbol	Parameter	-5		-7		-10		-15		Units
		Min	Max	Min	Max	Min	Max	Min	Max	
t_{IVDH}	Valid Input before PD High	5.0		7.5		10.0		15.0		ns
t_{GVDH}	Valid $\overline{OE}$ before PD High	0		0		0		0		ns
t_{CVDH}	Valid Clock before PD High	0		0		0				ns
t_{DHIX}	Input Don't Care after PD High		5.0		7.0		10.0		15.0	ns
t_{DHGX}	$\overline{OE}$ Don't Care after PD High		5.0		7.0		10.0		15.0	ns
t_{DHCX}	Clock Don't Care after PD High		5.0		7.0		10.0		15.0	ns
t_{DLIV}	PD Low to Valid Input		5.0		7.5		10.0		15.0	ns
t_{DLGV}	PD Low to Valid $\overline{OE}$		15.0		20.0		25.0		30.0	ns
t_{DLCV}	PD Low to Valid Clock		15.0		20.0		25.0		30.0	ns
t_{DLOV}	PD Low to Valid Output		20.0		25.0		30.0		35.0	ns

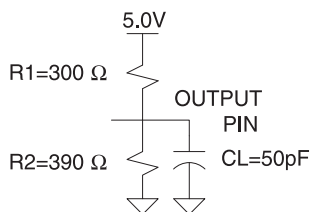
- Notes:
1. Output data is latched and held
 2. High-Z outputs remain high-Z
 3. Clock and input transitions are ignored

4.5 Input Test Waveforms

4.5.1 Input Test Waveforms and Measurement Levels



4.5.2 Commercial Output Test Loads



4.6 Pin Capacitance

Table 4-1. Pin Capacitance (f = 1MHz, T = 25°C⁽¹⁾)

	Typ	Max	Units	Conditions
C_{IN}	5	8	pF	$V_{IN} = 0V$
C_{OUT}	6	8	pF	$V_{OUT} = 0V$

- Note:
1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested

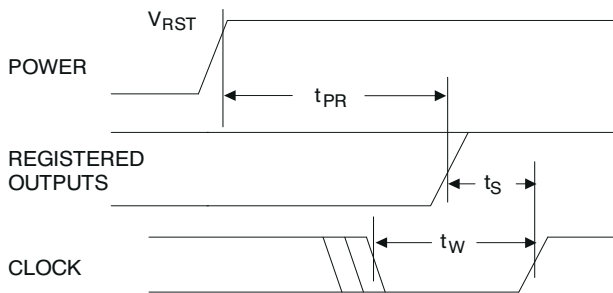
4.7 Power-up Reset

The registers in the Atmel® ATF22V10Cs are designed to reset during power-up. At a point delayed slightly from V_{CC} crossing V_{RST} , all registers will be reset to the low state. The output state will depend on the polarity of the output buffer.

This feature is critical for state machine initialization. However, due to the asynchronous nature of reset and the uncertainty of how V_{CC} actually rises in the system, the following conditions are required:

1. The V_{CC} rise must be monotonic, and starts below 0.7V
2. After reset occurs, all input and feedback setup times must be met before driving the clock pin high
3. The clock must remain stable during t_{PR}

Figure 4-1. Power-up Reset Timing



4.8 Preload of Registered Outputs

The ATF22V10C registers are provided with circuitry to allow loading of each register with either a high or a low. This feature will simplify testing since any state can be forced into the registers to control test sequencing. A JEDEC file with preload is generated when a source file with vectors is compiled. Once downloaded, the JEDEC file preload sequence will be done automatically by most of the approved programmers after the programming.

5. Electronic Signature Word

There are 64-bits of programmable memory that are always available to the user, even if the device is secured. These bits can be used for user-specific data.

6. Security Fuse Usage

A single fuse is provided to prevent unauthorized copying of the ATF22V10C fuse patterns. Once programmed, fuse verify and preload are inhibited. However, the 64-bit User Signature remains accessible.

The security fuse should be programmed last, as its effect is immediate.

7. Programming/Erasing

Programming/erasing is performed using standard PLD programmers. See “CMOS PLD Programming Hardware and Software Support” for information on software/programming.

Table 7-1. Programming/Erasing

Parameter	Description	Typ	Max	Units
t_{PR}	Power-up Reset Time	600	1,000	ns
V_{RST}	Power-up Reset Voltage	3.8	4.5	V

8. Input and I/O Pin-keeper Circuits

The Atmel® ATF22V10C contains internal input and I/O pin-keeper circuits. These circuits allow each ATF22V10C pin to hold its previous value even when it is not being driven by an external source or by the device's output buffer. This helps to ensure that all logic array inputs are at known valid logic levels. This reduces system power by preventing pins from floating to indeterminate levels. By using pin-keeper circuits rather than pull-up resistors, there is no DC current required to hold the pins in either logic state (high or low).

These pin-keeper circuits are implemented as weak feedback inverters, as shown in the Input Diagram below. These keeper circuits can easily be overdriven by standard TTL- or CMOS-compatible drivers. The typical overdrive current required is 40µA.

Figure 8-1. Input Diagram

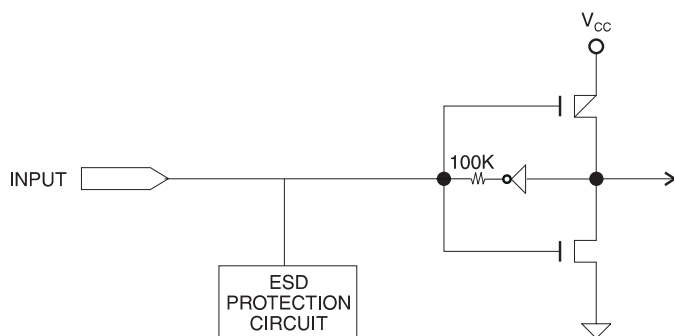
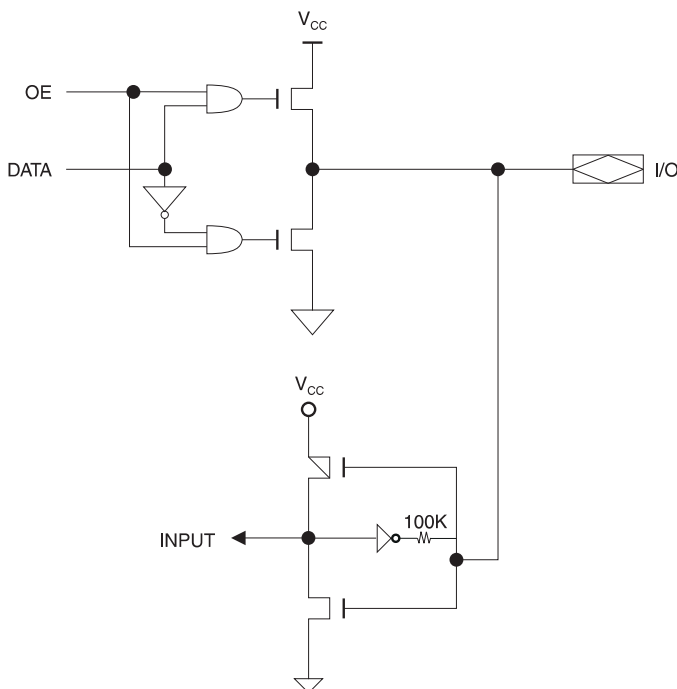
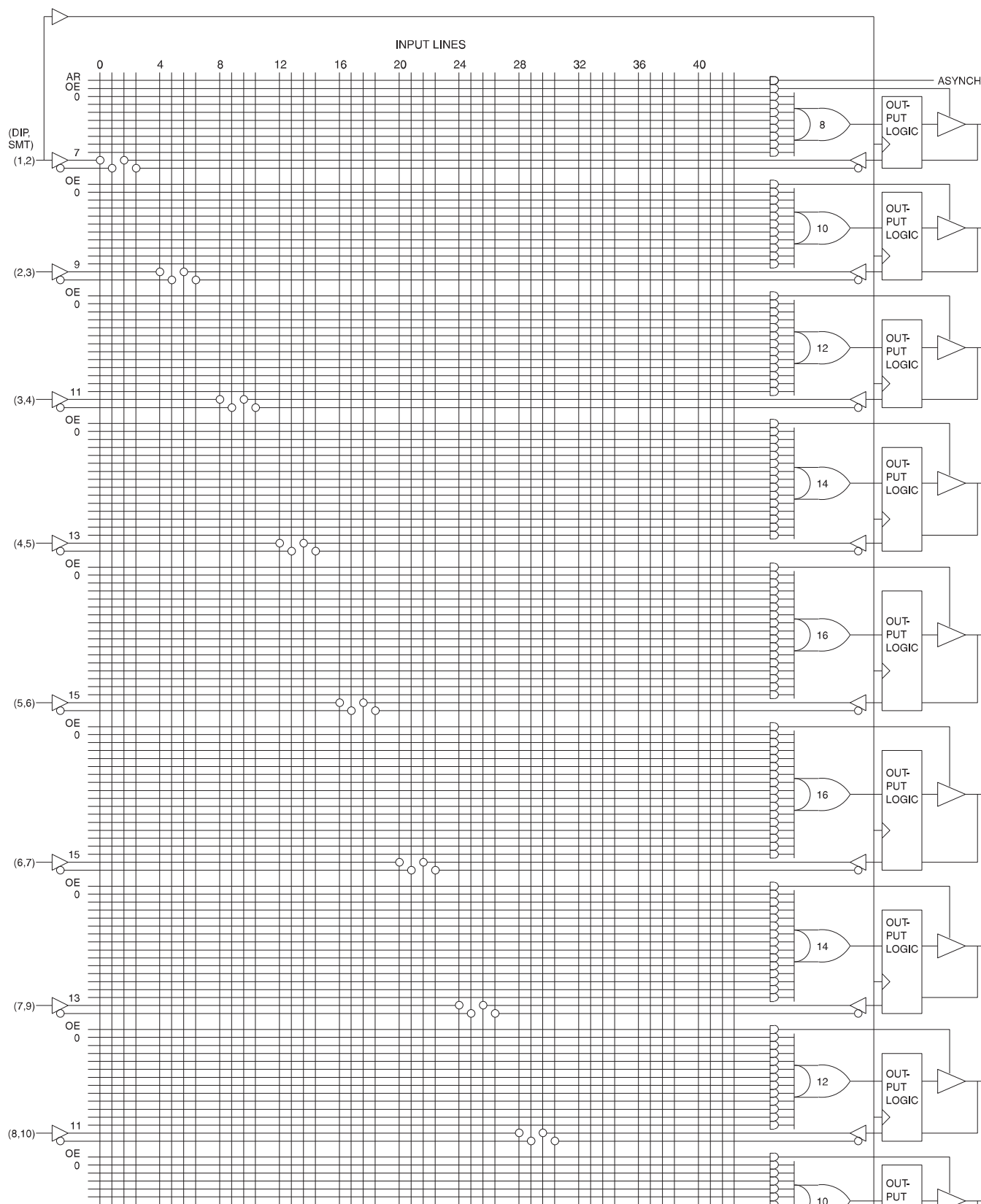


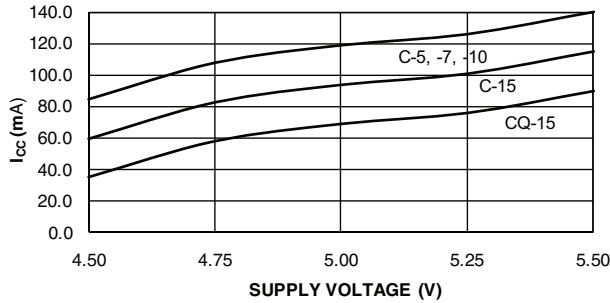
Figure 8-2. I/O Diagram



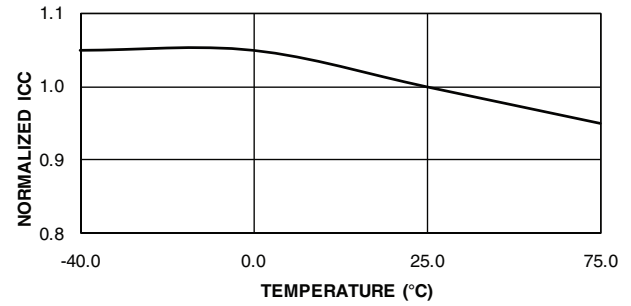
11. Functional Logic Diagram



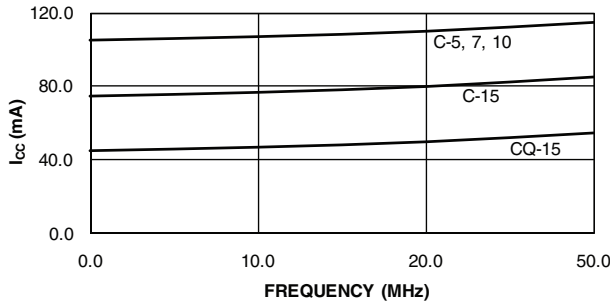
ATMEL ATF22V10C/CQ SUPPLY CURRENT VS. SUPPLY VOLTAGE ($T_A = 25^\circ\text{C}$)



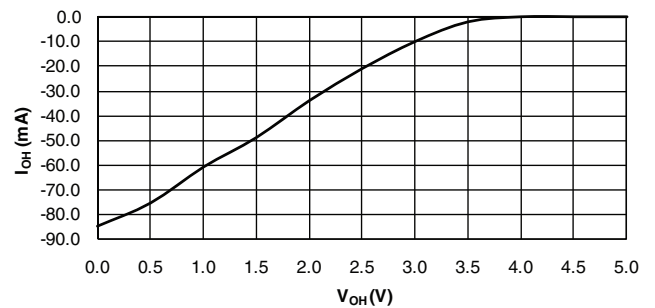
ATMEL ATF22V10C/CQ NORMALIZED I_{CC} VS. TEMPERATURE



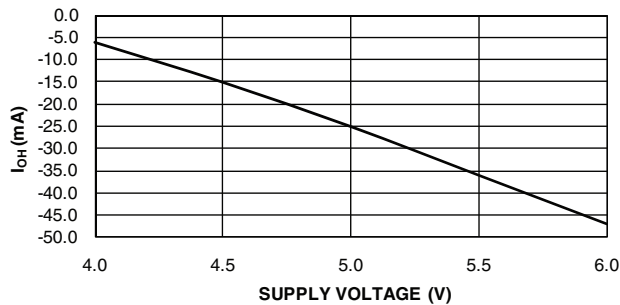
ATMEL ATF22V10C/CQ SUPPLY CURRENT VS. INPUT FREQUENCY ($V_{CC} = 5V, T_A = 25^\circ\text{C}$)



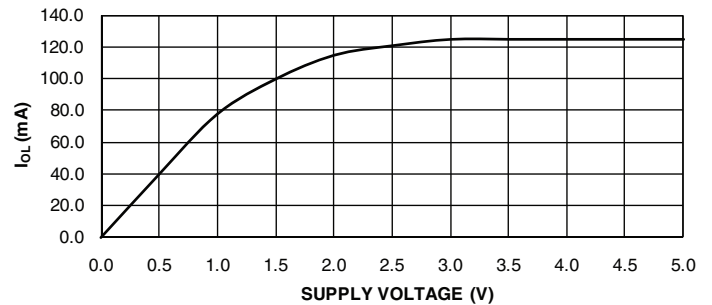
ATMEL ATF22V10C/CQ OUTPUT SOURCE CURRENT VS. OUTPUT VOLTAGE ($V_{CC} = 5V, T_A = 25^\circ\text{C}$)



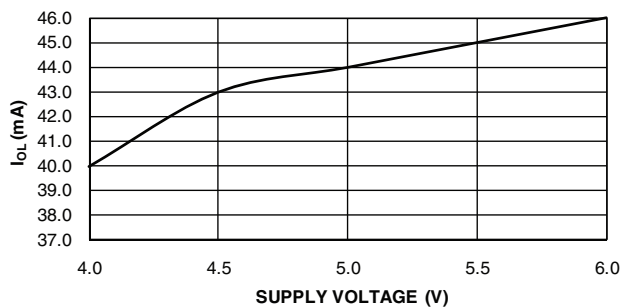
ATMEL ATF22V10C/CQ OUTPUT SOURCE CURRENT VS. SUPPLY VOLTAGE ($V_{OH} = 2.4V$)



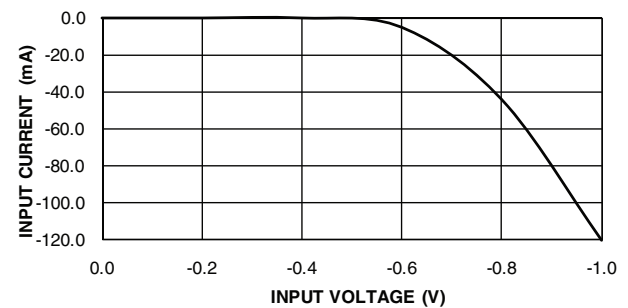
ATMEL ATF22V10C/CQ OUTPUT SINK CURRENT VS. SUPPLY VOLTAGE ($V_{OL} = 0.5V$)

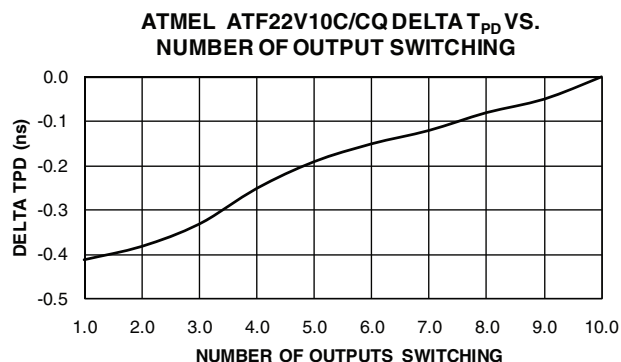
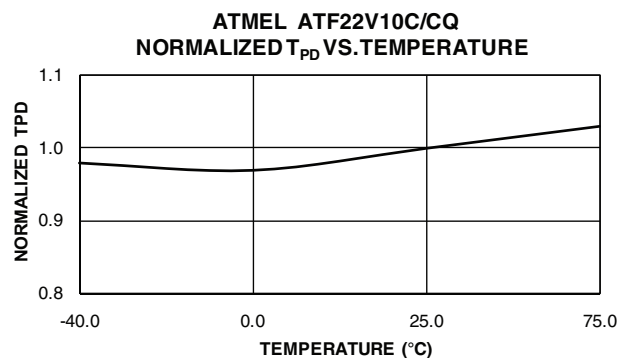
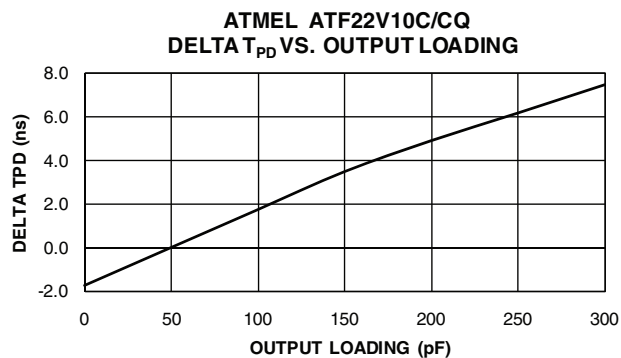
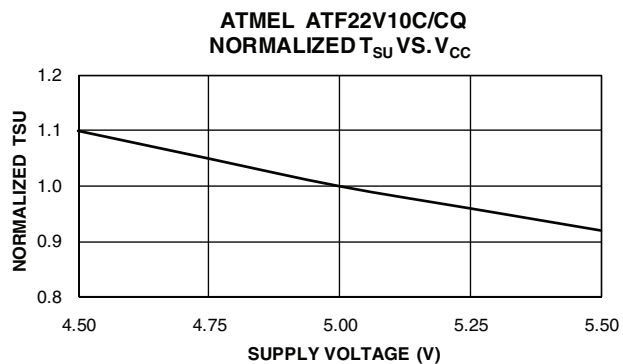
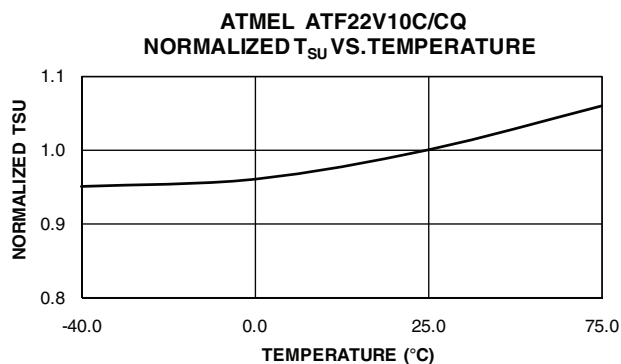
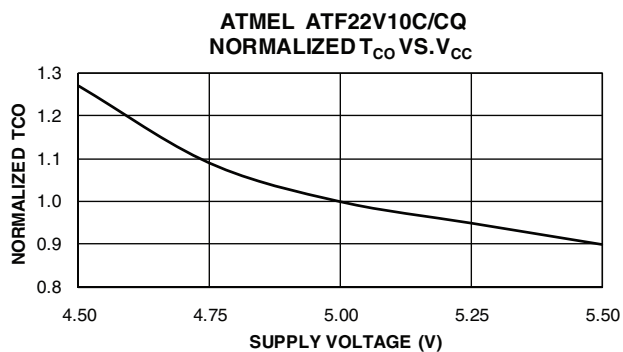
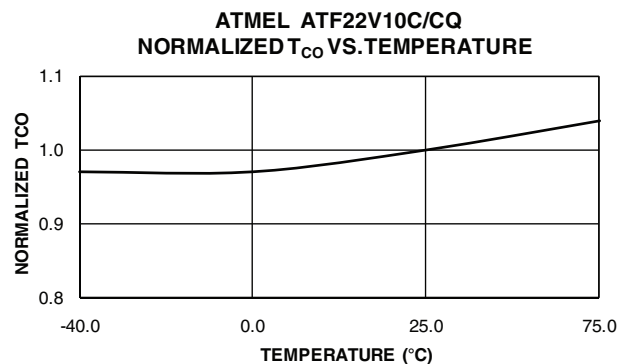
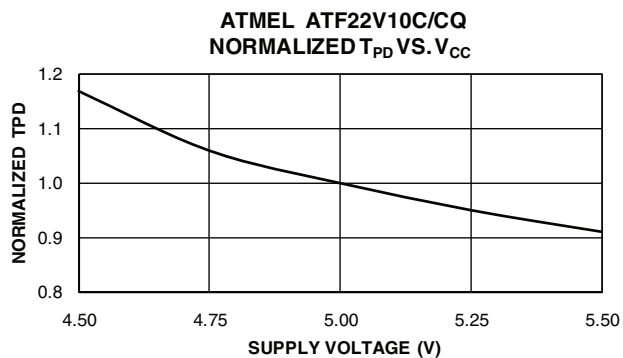


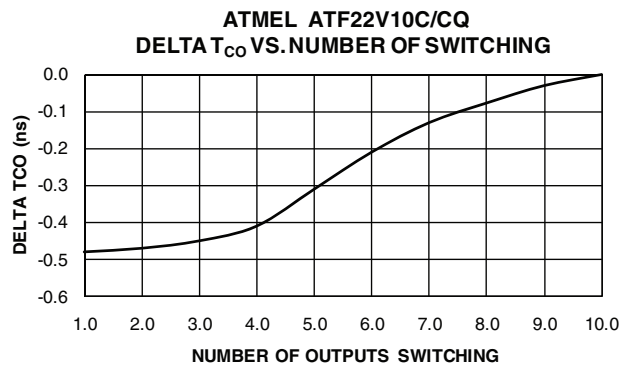
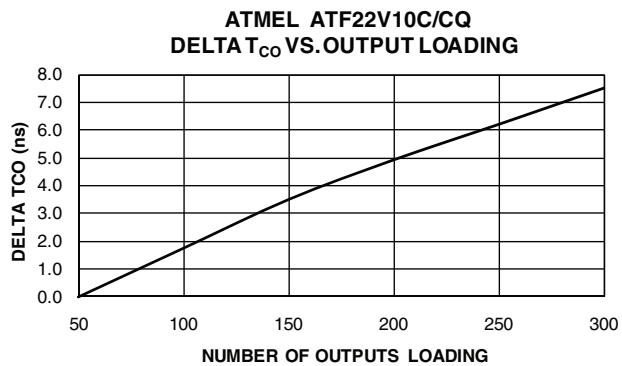
ATMEL ATF22V10C/CQ OUTPUT SINK CURRENT VS. SUPPLY VOLTAGE ($V_{OL} = 0.5V$)



ATMEL ATF22V10C/CQ INPUT CLAMP CURRENT VS. INPUT VOLTAGE ($V_{CC} = 5V, T_A = 35^\circ\text{C}$)







12. Ordering Information

12.1 Atmel ATF22V10C(Q) Green Package Options (Pb/Halide-free/RoHS Compliant)

t _{PD} (ns)	t _S (ns)	t _{CO} (ns)	Ordering Code	Package	Operation Range
5	3	4	ATF22V10C-5JX	28J	Commercial (0°C to 70°C)
7.5	3.5	4.5	ATF22V10C-7PX ATF22V10C-7SX	24P3 24S	Commercial (0°C to 70°C)
7.5	3.5	4.5	ATF22V10C-7JU	28J	Industrial (-40°C to 85°C)
10	4.5	6.5	ATF22V10C-10JU ATF22V10C-10PU ATF22V10C-10SU ATF22V10C-10XU	28J 24P3 24S 24X	Industrial (-40°C to 85°C)
15	10	8	ATF22V10C-15JU ATF22V10C-15PU	28J 24P3	Industrial (-40°C to 85°C)
			ATF22V10CQ-15JU	28J	Industrial (-40°C to 85°C)

12.2 Using “C” Product for Industrial

To use commercial product for industrial temperature ranges, down-grade one speed grade from the industrial-grade to the commercial-grade device (e.g. 7ns PX = 10ns PU) and de-rate power by 30%.

12.3 Military Package Options (Lead-based)⁽¹⁾

t _{PD} (ns)	t _S (ns)	t _{CO} (ns)	Ordering Code	Package	Operation Range
10	4.5	6.5	ATF22V10C-10GM/883 ATF22V10C-10NM/883	24D3 28L	Military (-55°C to 125°C) Class B, Fully Compliant
			5962-8984116LA 5962-89841163A	24D3 28L	
15	10	8	ATF22V10C-15GM/883 ATF22V10C-15NM/883	24D3 28L	Military (-55°C to 125°C) Class B, Fully Compliant
			5962-8984115LA 5962-89841153A	24D3 28L	

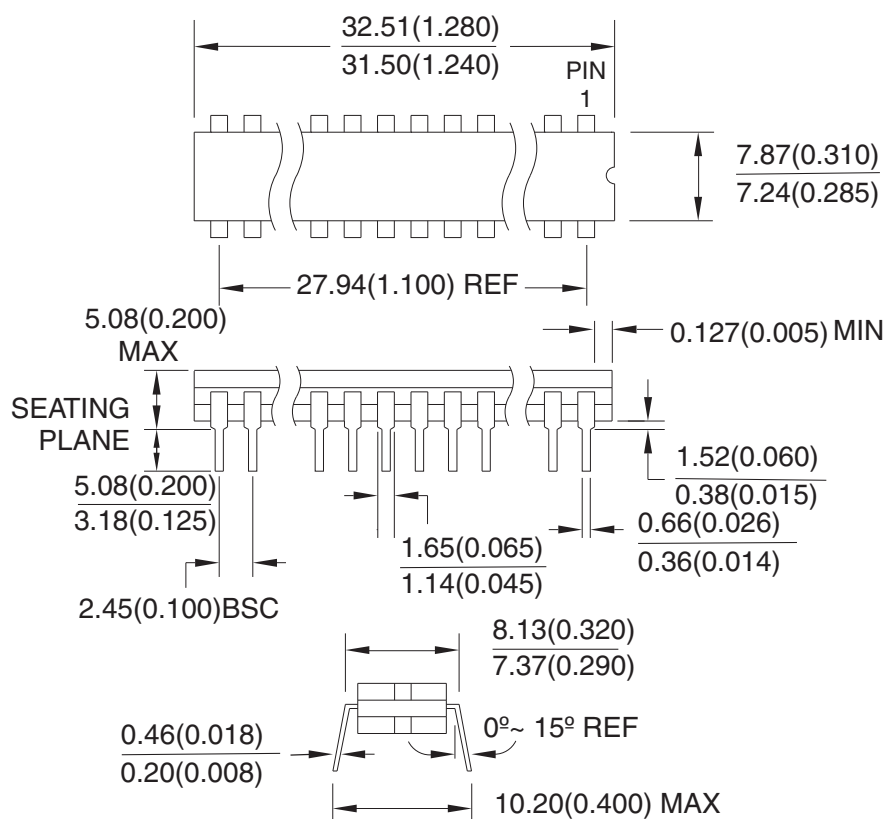
Notes: 1. Military/DSCC parts meet the DSCC drawing specifications

Package Type	
24D3	24-lead, 0.300" Wide, Non-windowed Ceramic Dual Inline Package (CERDIP)
24P3	24-pin, 0.300" Wide, Plastic Dual Inline Package (PDIP)
24S	24-lead, 0.300" Wide, Plastic Gull Wing Small Outline (SOIC)
24X	24-lead, 4.4mm Wide, Plastic Thin Shrink Small Outline (TSSOP)
28J	28-lead, Plastic J-leaded Chip Carrier (PLCC)
28L	28-lead, Ceramic Leadless Chip Carrier (LCC)

13. Packaging Information

13.1 24D3 – Cerdip

Dimensions in Millimeters and (Inches).
Controlling dimension: Inches.
MIL-STD 1835 D-9 Config A (Glass Sealed)



10/21/03



Package Drawing Contact:
packagedrawings@atmel.com

TITLE

24D3, 24-lead, 0.300" Wide. Non-windowed, Ceramic
Dual Inline Package (Cerdip)

DRAWING NO.

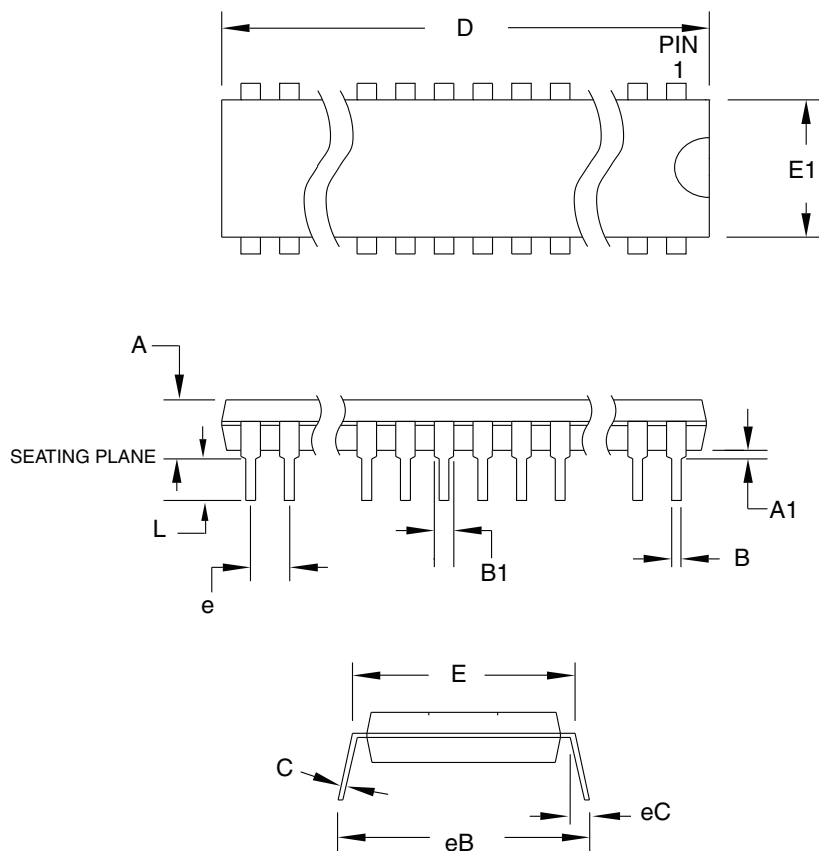
24D3

REV.

B



13.2 24P3 – PDIP



COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	5.334	
A1	0.381	–	–	
D	31.623	–	32.131	Note 2
E	7.620	–	8.255	
E1	6.096	–	7.112	Note 2
B	0.356	–	0.559	
B1	1.270	–	1.651	
L	2.921	–	3.810	
C	0.203	–	0.356	
eB	–	–	10.922	
eC	0.000	–	1.524	
e	2.540 TYP			

- Notes:
1. This package conforms to JEDEC reference MS-001, Variation AF
 2. Dimensions D and E1 do not include mold Flash or Protrusion
Mold Flash or Protrusion shall not exceed 0.25mm (0.010")

6/1/04



Package Drawing Contact:
packagedrawings@atmel.com

TITLE

24P3, 24-lead (0.300"/7.62mm Wide) Plastic Dual
Inline Package (PDIP)

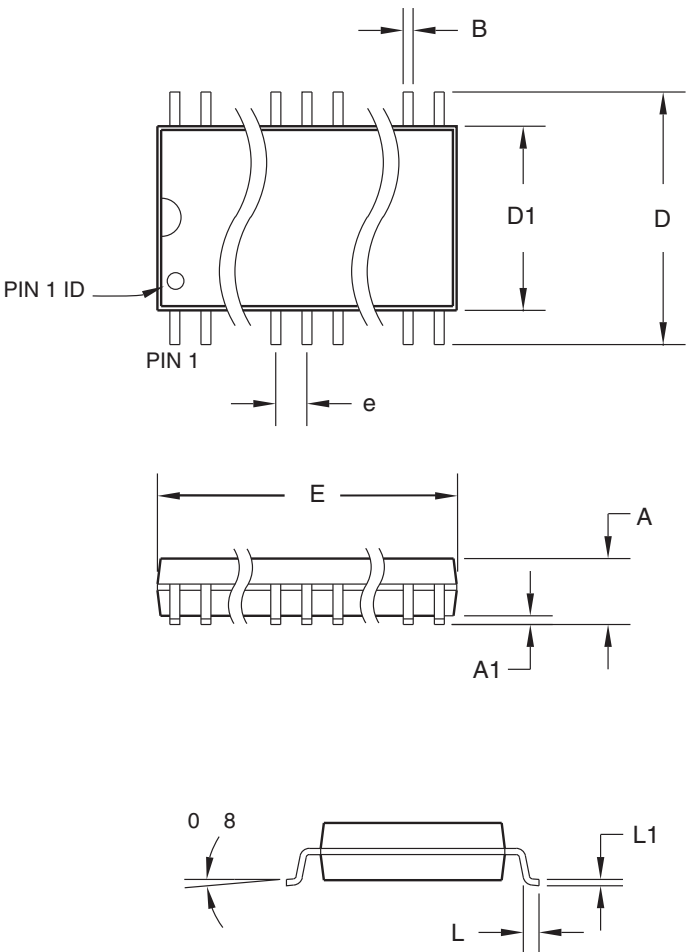
DRAWING NO.

24P3

REV.

D

13.3 24S – SOIC



COMMON DIMENSIONS
(Unit of Measure = mm)

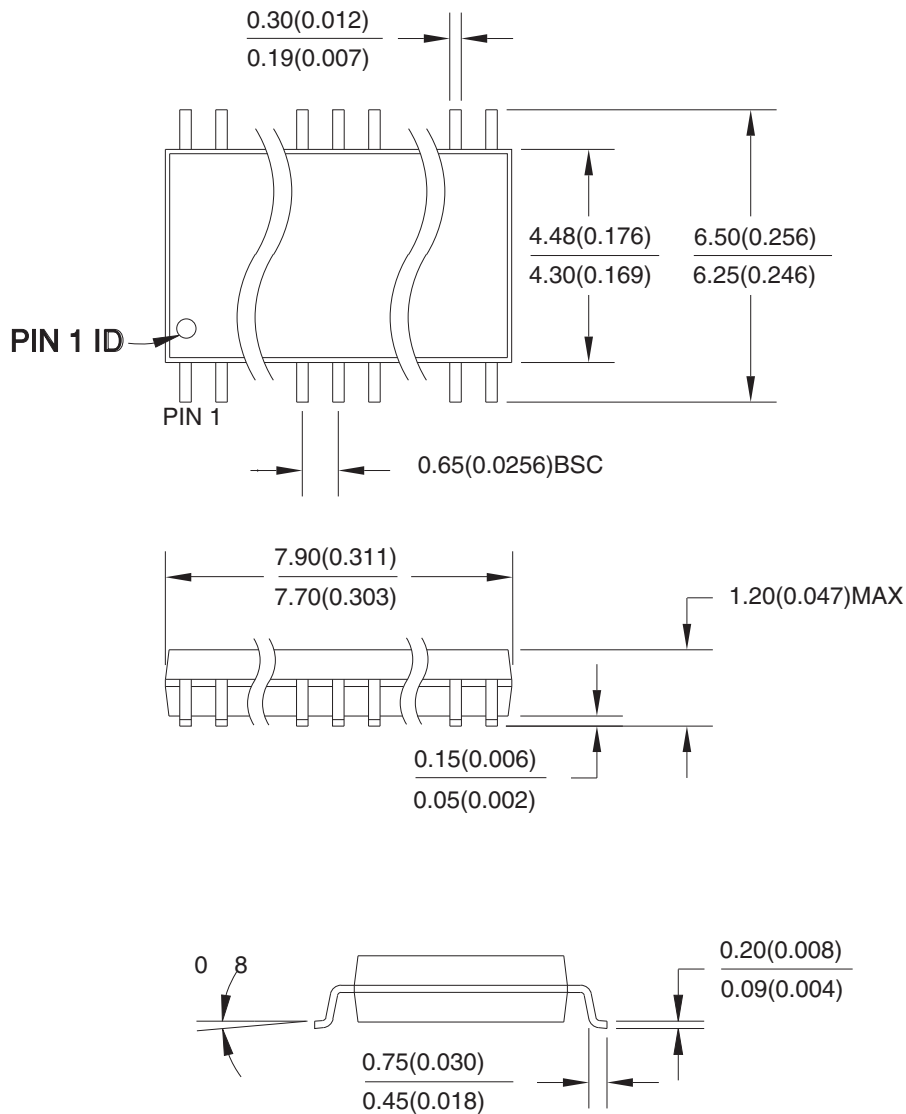
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	2.65	
A1	0.10	–	0.30	
D	10.00	–	10.65	
D1	7.40	–	7.60	
E	15.20	–	15.60	
B	0.33	–	0.51	
L	0.40	–	1.27	
L1	0.23	–	0.32	
e	1.27 BSC			

06/17/2002

 Package Drawing Contact: packagedrawings@atmel.com	TITLE 24S, 24-lead (0.300" body) Plastic Gull Wing Small Outline (SOIC)	DRAWING NO.	REV.
		24S	B

13.4 24X – TSSOP

Dimensions in Millimeter and (Inches)*
JEDEC STANDARD MO-153 AD
Controlling dimension: millimeters



04/11/2001



Package Drawing Contact:
packagedrawings@atmel.com

TITLE

24X, 24-lead (4.4mm body width) Plastic Thin Shrink
Small Outline Package (TSSOP)

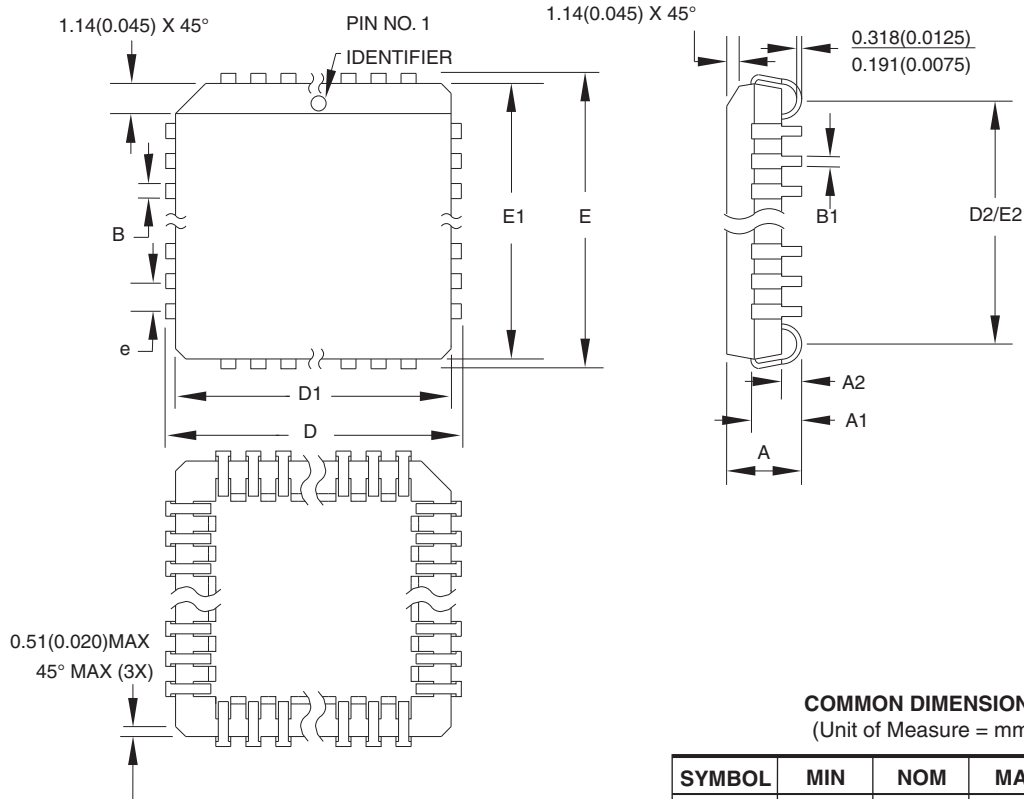
DRAWING NO.

24X

REV.

A

13.5 28J – PLCC



COMMON DIMENSIONS
(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
A	4.191	—	4.572	
A1	2.286	—	3.048	
A2	0.508	—	—	
D	12.319	—	12.573	
D1	11.430	—	11.582	Note 2
E	12.319	—	12.573	
E1	11.430	—	11.582	Note 2
D2/E2	9.906	—	10.922	
B	0.660	—	0.813	
B1	0.330	—	0.533	
e	1.270 TYP			

- Notes:
1. This package conforms to JEDEC reference MS-018, Variation AB
 2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010" (0.254mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line
 3. Lead coplanarity is 0.004" (0.102mm) maximum

10/04/01



Package Drawing Contact:
packagedrawings@atmel.com

TITLE

28J, 28-lead, Plastic J-leaded Chip Carrier (PLCC)

DRAWING NO.

28J

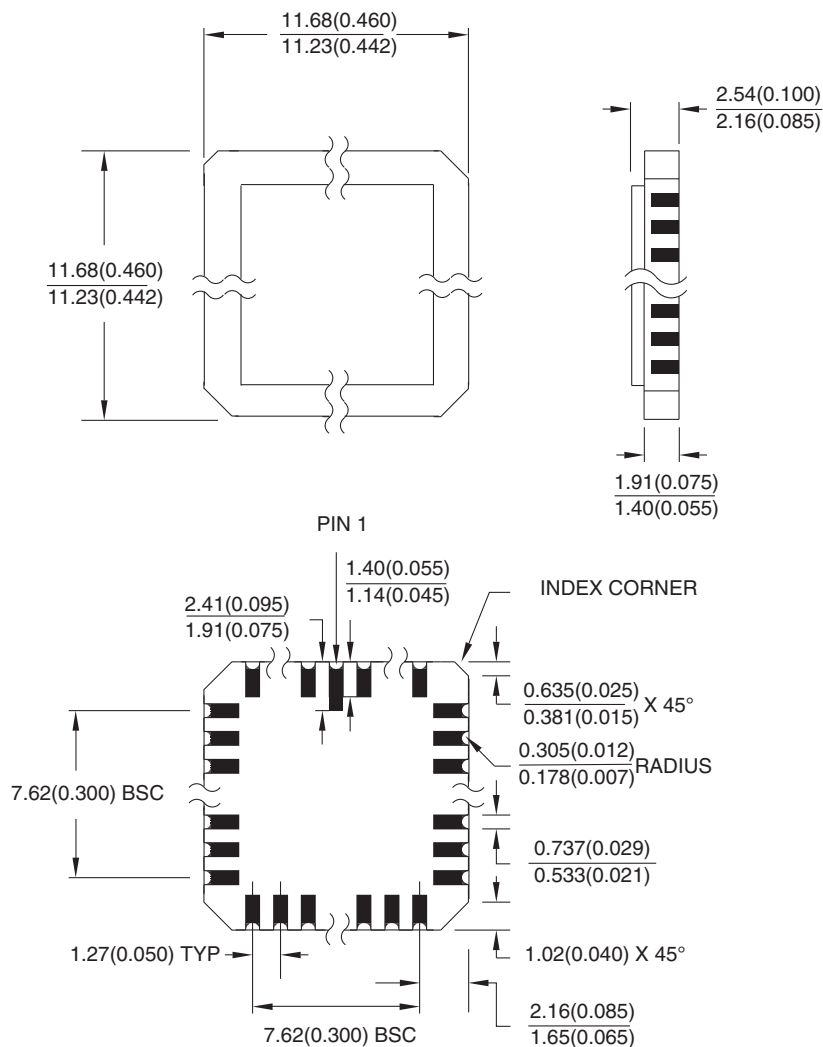
REV.

B



13.6 28L – LCC

Dimensions in Millimeters and (Inches).
Controlling dimension: Inches.
MIL-STD 1835 C-4



10/21/03



Package Drawing Contact:
packagedrawings@atmel.com

TITLE

28L, 28-pad, Non-windowed, Ceramic Lid, Leadless Chip Carrier (LCC)

DRAWING NO.

28L

REV.

B

14. Revision History

Doc. Rev.	Date	Comments
0735U	05/2010	Updated C-15 military device I_{CC} limit Revised the maximum power supply current in PD mode for commercial- and industrial-grade devices from 100 μ A to 500 μ A and 100 μ A to 650 μ A maximum, respectively C-15 and CQ-15 Commercial part removed from Table 4-1 . Removed Mil from I_{CC} , C-15 (Ind.) parts I_{CC2} at 15mhz Max changed from 90mA to 125mA
0735T	05/2009	Added military-grade packages and removed leaded parts
0735S	08/2008	Added new green part
0735R	06/2008	Updated Green package options



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